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**Part Number:** [0901361102](#)  
**Status:** **Active**  
**Overview:** [C-Grid III Interconnects](#)  
**Description:** C-Grid III Header, Single Row, Vertical, Shrouded, 2 Circuits, 4µm Tin/Lead (Sn) over Nickel (Ni)

**Documents:**

<a href="#">3D Model</a>	<a href="#">Application Specification 901190001-AS-000 (PDF)</a>
<a href="#">Drawing (PDF)</a>	<a href="#">Packaging Specification PK-90136-001-001 (PDF)</a>
<a href="#">3D Model (PDF)</a>	<a href="#">RoHS Certificate of Compliance (PDF)</a>
<a href="#">Product Specification PS-99020-0001-001 (PDF)</a>	



**Agency Certification**

CSA	LR19980
UL	E29179

**General**

Product Family	PCB Headers
Series	<a href="#">90136</a>
Application	Signal, Wire-to-Board
Overview	<a href="#">C-Grid III Interconnects</a>
Product Name	C-Grid III
UPC	800753532762

**Physical**

Breakaway	No
Circuits (Loaded)	2
Circuits (maximum)	2
Color - Resin	Black
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Metal	Brass
Material - Plating Mating	Tin
Material - Plating Termination	Tin
Material - Resin	Polyester
Net Weight	0.506/g
Number of Rows	1
Orientation	Vertical
PC Tail Length	2.90mm
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
Packaging Type	Tray
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	3.048µm
Plating min - Termination	3.048µm
Polarized to PCB	No
Shrouded	Fully
Stackable	No
Temperature Range - Operating	-55° to +125°C
Termination Interface: Style	Through Hole

**EU ELV**

**Not Relevant**

**EU RoHS**

**Compliant**

**REACH SVHC**

Not Contained Per -  
D(2021)4569-DC (8  
July 2021)

**Halogen-Free**

**Status**

**Not Low-Halogen**

For more information, please visit [Contact US](#)

China ROHS

ELV

RoHS Phthalates

**China RoHS**

Green Image

Not Relevant

Not Contained

**Search Parts in this Series**

[90136](#) Series

**Mates With**

[90123](#) C-Grid III Modular Crimp Housing,  
[90156](#) C-Grid III Crimp Housing

**Electrical**

Current - Maximum per Contact	3.0A
Voltage - Maximum	350V AC/DC

**Solder Process Data**

Duration at Max. Process Temperature (seconds)	003
Lead-free Process Capability	WAVE
Max. Cycles at Max. Process Temperature	001
Process Temperature max. C	235

**Material Info****Reference - Drawing Numbers**

Application Specification	901190001-AS-000
Packaging Specification	PK-90136-001-001
Product Specification	PS-99020-0001-001
Sales Drawing	SDA-90136-001

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